



IPS / 1000cd/m² with and without PCAP

FEATURES

- 7" TFT 1024X600 DOTS
- HIGH BRIGHTNESS (1000(800)cd/m²)
- IPS TECHNOLOGY FOR WIDEST VIEWING ANGEL AND TRUE COLORS

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- LVDS 6/8 BIT INTERFACE
- OPTIONAL PCAP TOUCHPANEL
- INCL. CONTROLLER GT911 (I2C) FOR 5 FINGER OPERATION

ORDERING INFORMATION

7" TFT IPS - 1024X600 DOTS, LVDS

• 7" TFT IPS - 1024X600 DOTS, LVDS WITH PCAP

EA R1024X-70BLW EA R1024X-70BLWTS





REVISION HISTORY

Date	Rev.	Page	Description
2017-06-26	1.0	All	First Issue
2018-11-26	1.0	1, 14, 19	Ordering code changed to "TS"





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1. General Features

Item	Spec	Remark
Display Mode	Normally Black transmissive	
Viewing Direction	Free	
Input Signals	LVDS 6/8 bits	
Outside Dimensions(mm)	164.9 (W) x100(H) x5.7 (D)	
Outside Dimensions(mm)	164.9 (W) x100(H) x7.6 (D)	With CTP
Active Area(mm)	154.21(W)×85.92(H)	
Number of Pixels	1024(RGB)×600	
Dot Pitch(mm)	0.1506 (H) x 0.1432 (V)	
Pixel Arrangement	RGB Vertical stripes	
Drive IC		
CTP Drive IC (optional)	GT911	







2. Absolute Maximum Ratings

The following are maximum values which, if exceeded may cause operation or damage to the unit.

ITEM	Sym.	Min.	Тур.	Max.	Unit	Remark
	VDD	-0.3	ı	3.96	V	
Dower for Circuit Driving	AVDD	-0.5		14.85	V	
Power for Circuit Driving	VGH	-0.3		40	V	
	VGL	-20		0.3	V	
Storage Humidity	Hst	10	-		%RH	
Storage Temperature	Tst	-30	-	80		At
Operating Ambient Humidity	Нор	10	-		%RH	25±5 ℃
Operating Ambient temperature	Тор	-20	-	70		





3. Electrical Specification

3.1 Driving TFT LCD Panel

Item	Symbol	Min.	Тур.	Max.	Unit	Note
	DVDD	3.0	3.3	3.6	V	
Supply Voltage	VGH	17	18	19	V	
	VGL	-6.6	-6	-5.4	V	
	AVDD	9.4	9.6	9.8	V	
	Vcom	3.6	3.8	4.0		
Video signal	VIA	-	-	AVDD -0.4	V	
amplitude	VIAC	-	-	12	V	AC component,
(VR,VG,VB)	VIDC	-	AVDD/2	12	V	DC component
VCOM	Vcac			9-4	VP-P	AC component
VCOM	VcDc	-	11=1	1-	V	DC component, (1)
Input signal	VIH	0.7DVpp	.=	DVpp	V	(2)
voltage	VIL	0		0.3DVpp	V	(2)
	IDD	-	30	45	mA	DV DD=3.3V
Current of power	IADD	-	35	45	mA	AVDD=9.6V
current or power	lgн	-	0.5	1	uA	V _{GH} =18V
supply	IGL	_	0.5	1	mA	V _G L=-6V

Note (1): The brightness of LCD panel could be changed by adjusting the AC component of VCOM.

Note (2): STHL, STHR, OEH, L/R, CPH1~CPH3, STVD, STVU, OEV, CKV, U/D

3.2 Driving LED Backlight

Item	Sym.	Min	Тур.	Max	Unit	Note
Backlight driving voltage	VF	9.0	9.6	10.2	V	
Backlight driving current	lF	1	270	1	mA	
Backlight Power Consumption	WBL	1	2592	-	mW	
Life Time	-	ı	30,000	-		Note 1

Note 1: If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced. Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.



3.3 Power Consumption

ITEM	SYMBOL	CONDITION	MIN	TYPE	MAX	UNIT	NOTE
Gate on power current	IVGH	VGH =18V		0.5	1	mA	Note1
Gate off power current	IVGL	VGL= -6V		0.5	1	mA	Note1
Digital power current	IDVDD	DVDD = 3.3V		30	45	mA	Note1
Analog power current	IAVDD	AVDD = 9.6V		35	45	mA	Note1
Total Power Consumption	PC			447	604	mW	Note1

Note1: Typ. specification : Gray-level test Pattern Max. specification : Black test Pattern







Black Pattern

3.4 Driving CTP

Item	Value
Working Voltage	DC 3.3V
Interface	I2C
Support Touch	5 Points





4. Optical Specifications

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 30 minutes in a dark environment at 25 °C. The values specified are at an approximate distance 500mm from the LCD surface at a viewing angle of Φ and θ equal to 0° .

Ho	Curre		Values		11:4:4	Note	
ltem	Sym.	Min.	Тур.	Max.	Unit	Note	
1)Contrast Ratio	C/R	-	800	-		FIG.1	
2)Module Luminance	L	ı	1000	ı	a d /ras 2	w./o. CTP	
2)Module Editiliance	L	ı	800	-	cd/m ²	After CTP	
3)Response time	Tr+Tf	-	35	ı	ms	FIG.2	
	θτ	ı	85	-			
4)Viouing Anglo	θв	-	85	-	Dograd	FIG.3	
4)Viewing Angle	Θ_{L}	-	85	-	Degree		
	θR	-	85	-		_	
	Wx	0.27	0.31	0.35			
	Wy	0.29	0.33	0.37			
	Rx	-	-	-			
E)Chromotioity	Ry	-	-	-			
5)Chromaticity	Gx	-	-	-			
	Gy	-	-	-			
	Вх	-	-	-			
	Ву	-	-	-			





♦ Measurement System

Notes:

1. Contrast Ratio(CR) is defined mathematically as:

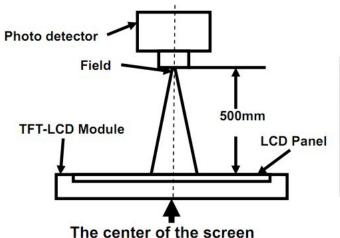
Surface Luminance with all white pixels

Contrast Ratio = ------

Surface Luminance with all black pixels

- 2. Surface luminance is the center point across the LCD surface 500mm from the surface with all pixels displaying white. For more information see FIG 1.
 - 3. Response time is the time required for the display to transition from white to black (Rising Time, Tr) and from black to white (Falling Time, Tf). For additional information see FIG 2.
 - 4. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

FIG. 1 Optical Characteristic Measurement Equipment and Method



Item	Photo detector	Field	
Contrast Ratio		1°	
Luminance	00.04		
Chromaticity	SR-3A	1	
Lum Uniformity			
Response Time	BM-7A	2°	





FIG. 2 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

Response Time = Rising Time(Tr) + Falling Time(Tf)

- Rising Time(Tr) : Full White 90% \rightarrow Full White 10% Transmittance.
- Falling Time(Tf): Full White 10% → Full White 90% Transmittance.

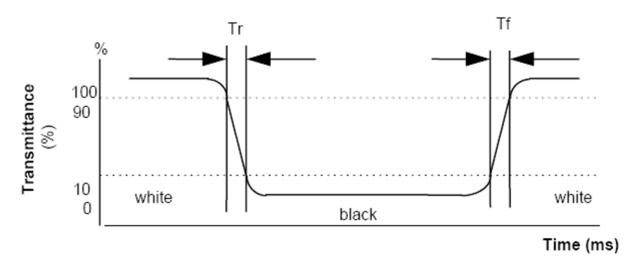
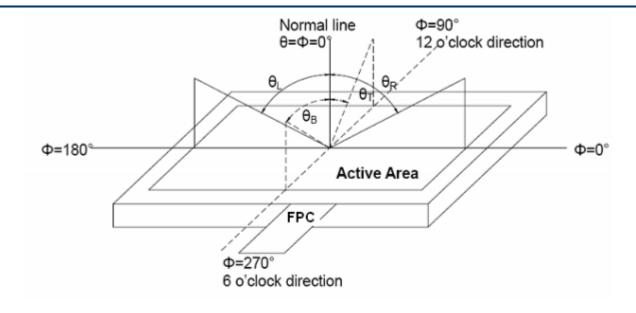


FIG. 3 The definition of Viewing Angle

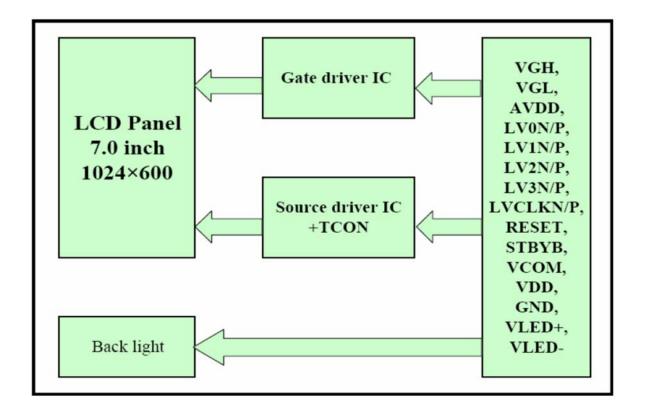
Use Fig. 1(Test Procedure) under Measurement System to measure the contrast from the measuring direction specified by the conditions as the following figure.







5. Block Diagram







6.Pin Description

6.1 TFT LCD Panel

Pin No.	Symbol	I/O	Function	Remark
1	VCOM	Р	Common Voltage	
2	VDD	Р	Power Voltage for digital circuit	
3	VDD	Р	Power Voltage for digital circuit	
4	NC		No connection	
5	Reset	1	Global reset pin	
6	STBYB	ı	Standby mode, Normally pulled high STBYB = "1", normal operation STBYB = "0", timing controller, source driver will turn off, all output are High-Z	
7	GND	Р	Ground	
8	RXIN0-	1	- LVDS differential data input	
9	RXIN0+	1	+ LVDS differential data input	
10	GND	Р	Ground	
11	RXIN1-	1	- LVDS differential data input	
12	RXIN1+	1	+ LVDS differential data input	
13	GND	Р	Ground	
14	RXIN2-	T	- LVDS differential data input	
15	RXIN2+	T	+ LVDS differential data input	
16	GND	Р	Ground	
17	RXCLKIN-	I	- LVDS differential clock input	
18	RXCLKIN+	- 1	+ LVDS differential clock input	
19	GND	Р	Ground	
20	RXIN3-	1	- LVDS differential data input	
21	RXIN3+	1	+ LVDS differential data input	
22	GND	Р	Ground	
23	NC		No connection	





24	NC		No connection		
25	GND	Р	Ground		
26	NC		No connection		
27	NC	-			
28	SELB	1	6bit/8bit mode select	Note1	
29	AVDD	Р	Power for Analog Circuit		
30	GND	Р	Ground		
31	LED-	Р	LED Cathode		
32	LED-	Р	LED Cathode		
33	L/R	- 1	Horizontal inversion 80	Note3	
34	U/D	Ţ	Vertical inversion	Note3	
35	VGL	Р	Gate OFF Voltage		
36	NC			8	
37	NC	*			
38	VGH	Р	Gate ON Voltage		
39	LED+	Р	LED Anode		
40	LED+	Р	LED Anode		

I: input, O: output, P: Power

Note1: If LVDS input data is 6 bits ,SELB must be set to High;

If LVDS input data is 8 bits ,SELB must be set to Low.

Note2: When CABC_EN="00", CABC OFF.

When CABC_EN="01", user interface image. When CABC_EN="10", still picture. When CABC_EN="11", moving image.

When CABC off, don't connect DIMO, else connect it to backlight.

Note3: When L/R="0", set right to left scan direction.

When L/R="1", set left to right scan direction. When U/D="0", set top to bottom scan direction.





6.2 U/D R/L Function Description

Scan Co	ntrol Input	Seenning Direction
UPDN	SHLR	Scanning Direction
GND	VDD	Up to Down, Left to Right
VDD	GND	Down to Up, Right to Left
GND	GND	Up to Down, Right to Left
VDD	VDD	Down to Up, Left to Right

6.3 CTP LCD Pin Description (EA R1024X-70BLWTS only)

Pin	Symbol	Description
1	SDA	I2C data
2	SCL	I2C clock
3	RST	Reset
4	INT	Interrupt
5	VDD	Working voltage 3.3V
6	GND	GND

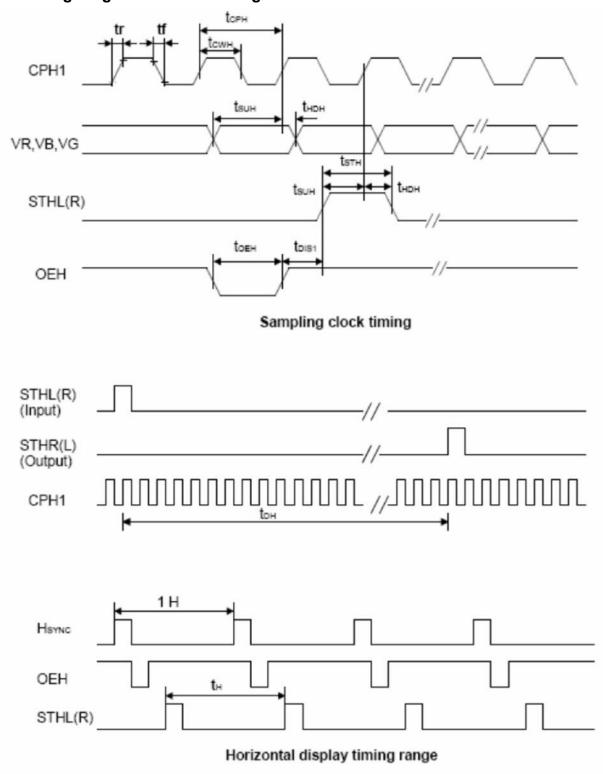
CTP IC driver GT911 source code will be offered separately





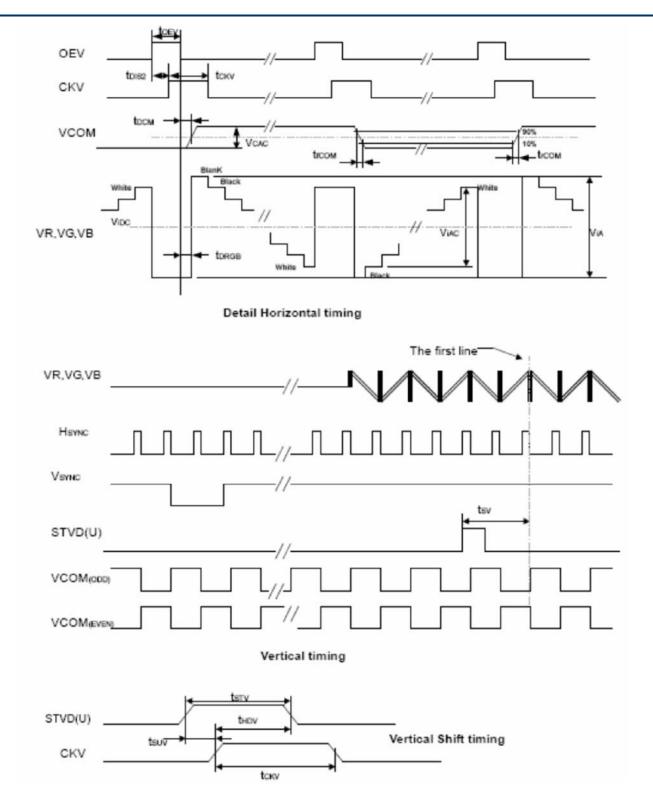
7. Timing Characteristics

7.1 Timing Diagram of Interface Signal







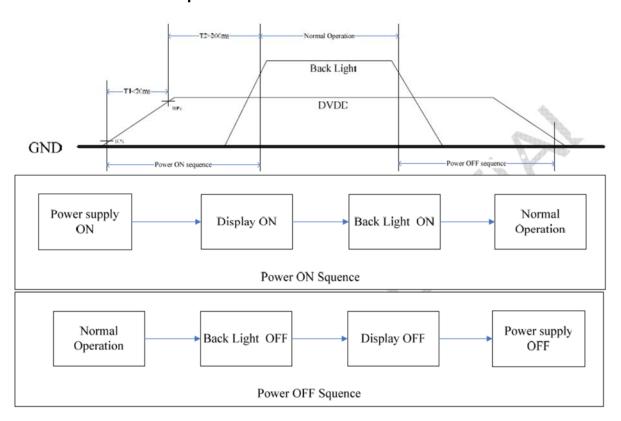






ITEM		SYMBOL	MIN.	TYP.	MAX.	UNIT	Note	
DE MODE	Dot Clock	1/tCLK	45	51.2	57	MHz		
	DCLK pulse duty	Tcwh	40	50	60	%		
	Horizontal total Time	tH	1324	1344	1364	tCLK		
	Horizontal effective Time	tHA	1024		tCLK			
	Horizontal Blank Time	tHB	300	320	340	tCLK		
	Vertical total Time	tV	625	635	645	tH		
	Vertical effective Time	tVA	600		tH			
	Vertical Blank Time	tVB	25	35	45	tH		
SYNC MODE	Horizontal total Time	TH	1324	1344	1364	tCLK		
	Horizontal Pulse Width	Thpw		20	-	tCLK	thb + thpw =160DCLK is fixed	
	Horizontal Back Porch	Thb		140	-	tCLK		
	Horizontal Front Porch	Thfp	140	160	180	tCLK		
	Horizontal effective Time	THA	1024		tCLK			
	Vertical total Time	TV	625	635	645	tH		
	Vertical Pulse Width	Tvpw		3	-	th	tvpw + tvb =23th is fixed	
	Vertical Back Porch	Tvb	-	20	-	th		
	Vertical Front Porch	Tvfp	2	12	22	th		
	Vertical Valid	Tvd	600		th			

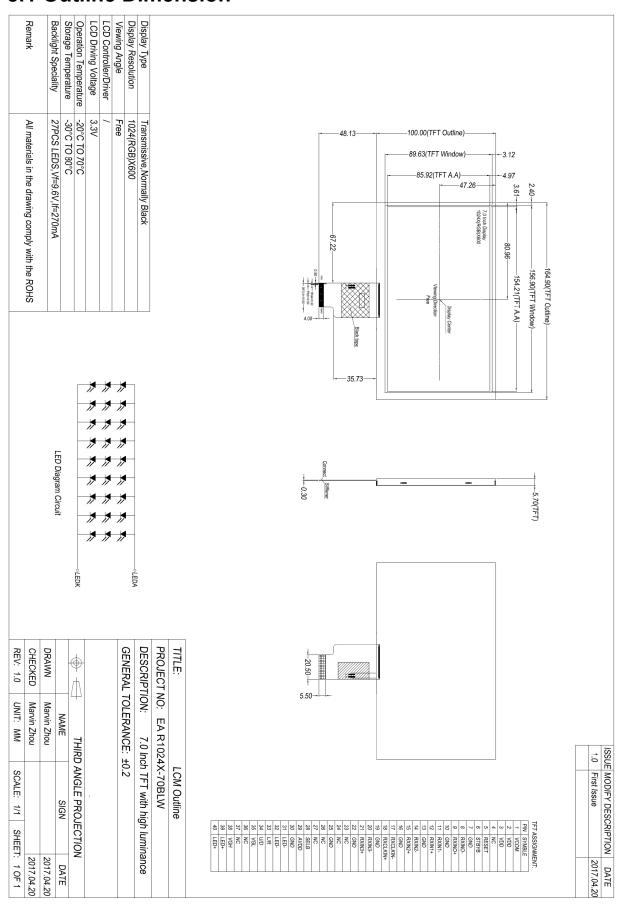
7.2 Power On/Off Sequence







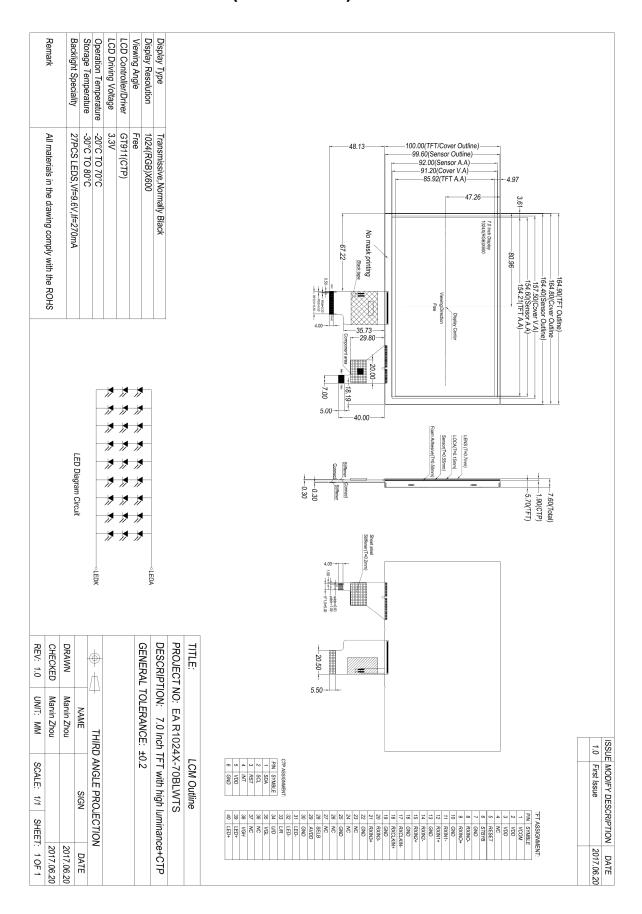
8.1 Outline Dimension







8.2 Outline Dimension (incl. PCAP)







9. Reliability and Inspection Standard

No.	Test Iten	n	Test Conditions	Remark	
1	High Temperature	Storage	80℃, 120Hr	Note	
		Operation	70 ℃, 120 Hr	Note	
2	Low Temperature	Storage	-30℃, 120Hr	Note	
		Operation	-20℃, 120Hr		
3	High Temperature and High Humidity		40℃, 90%RH, 120Hr	Note	
4	Peeling Off (Storage)		≧500gf/cm	Note	
5	FPC Bending	Test	≧6,000 times, 2/sec	Note	
6	Vibration Test(S	torage)	50HZ, 30min, Amplitude: 2 cm, X/Y/Z directions	Note	
7	Drop Tes	t	60cm/ 3Corner/ 8Face, 1Cycle	Note	

Note:

- 1) The test samples should be applied to only one test item.
- 2) Sample size for each test item is 5~10pcs.
- 3) For Damp Proof Test, pure water(Resistance> $1M\Omega$) should be used.
- 4) In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.
- 5) EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and fluorescence EL has.
- 6) After the reliability test, the test samples should be inspected after 2 hours at least.
- 7) Functional test is OK. Missing segment, shorts, unclear segment, non display, display abnormally, liquid crystal leak are not allowed.
- 8) After testing, the current Idd should be within initial value ±20%.
- 9) No low temperature bubbles ,end seal loose and fall, frame rainbow, ACF bubble growing are allowable in the appearance test.





10.PRECAUTIONS FOR USING LCD MODULES

Handing Precautions

- (1) The display panel is made of glass and polarizer. As glass is fragile, it tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
 - Isopropyl alcohol
 - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
 - Water
 - Ketone
 - Aromatic solvents
 - Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.
- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- (9) Do not attempt to disassemble or process the LCD module.
- (10) NC terminal should be open. Do not connect anything.
- (11) If the logic circuit power is off, do not apply the input signals.





- (12) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
 - Do not alter, modify or change the shape of the tab on the metal frame.
 - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
 - Do not damage or modify the pattern writing on the printed circuit board.
 - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
 - Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
 - Do not drop, bend or twist LCM.

Storage Precautions

When storing the LCD modules, the following precaution is necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability. To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- -Terminal electrode sections.